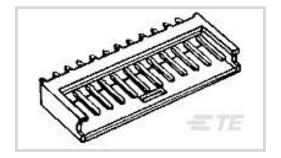
# 280370-1 🗸 ACTIVE

#### AMPMODU | AMPMODU Headers

TE Internal #: 280370-1 PCB Mount Header, Vertical, Board-to-Board, 2 Position, 2.54 mm [. 1 in] Centerline, Partially Shrouded, Tin, Through Hole - Solder, AMPMODU Headers

View on TE.com >

Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Vertical

Connector System: Board-to-Board

Number of Positions: 2

Number of Rows: 1

### Features

#### Product Type Features

PCB Connector Assembly Type

Connector System

Header Type

PCB Mount Header

Board-to-Board

Partially Shrouded



Sealable	No	
Connector & Contact Terminates To	Printed Circuit Board	
Configuration Features		
Connector Contact Load Condition	Fully Loaded	
PCB Mount Orientation	Vertical	
Number of Positions	2	
Number of Rows	1	
Electrical Characteristics		
Dielectric Withstanding Voltage (Max)	750 V	
Body Features		
Connector Profile	Standard	
Primary Product Color	Black	
Contact Features		
PCB Contact Termination Area Plating Material Thickness	3.5 µm	
Contact Shape & Form	Round	

**C** For support call+1 800 522 6752

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Contact Mating Area Plating Material Finish	Bright
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Phosphor Bronze
Contact Mating Area Plating Material	Tin
Contact Type	Pin
Termination Features	
Termination Post & Tail Length	3.5 mm[.138 in]
Termination Method to Printed Circuit Board	Through Hole - Solder
Mechanical Attachment	
Mating Retention	With
Panel Mount Feature	Without
Mating Alignment	With
Mating Alignment Type	Polarization
PCB Mount Retention	Without
PCB Mount Alignment	Without
Connector Mounting Type	Board Mount

#### **Housing Features**

Centerline (Pitch)	2.54 mm[.1 in]	
Housing Material	Thermoplastic	
Dimensions		
Row-to-Row Spacing	2.54 mm[.1 in]	
Usage Conditions		
Housing Temperature Rating	Standard	
Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]	
Operation/Application		
Circuit Application	Power & Signal	
Packaging Features		
Packaging Quantity	1500	
Packaging Type	Box	

### Product Compliance

For compliance documentation, visit the product page on TE.com>

PCB Mount Header, Vertical, Board-to-Board, 2 Position, 2.54 mm [.1 in] Centerline, Partially Shrouded, Tin, Through Hole - Solder, AMPMODU Headers



EU RoHS Directive 2011/65/EU	Compliant	
EU ELV Directive 2000/53/EC	Compliant	
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold	
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC	
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.	
Solder Process Capability	Wave solder capable to 265°C	

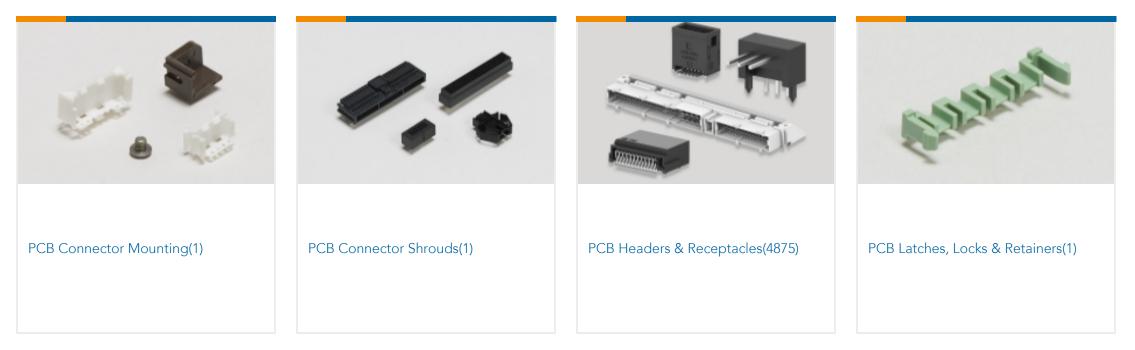
#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

## **Compatible Parts**

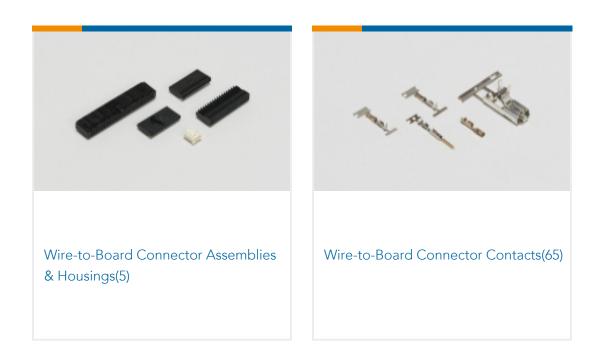


### Also in the Series AMPMODU Headers

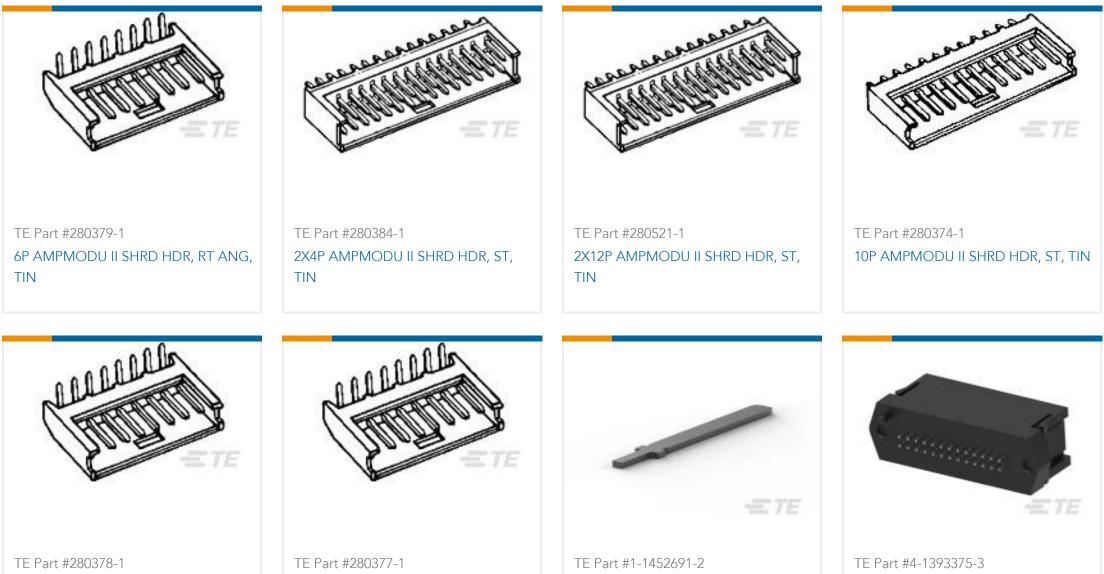


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# Customers Also Bought



4P AMPMODU II SHRD HDR, RT ANG, TIN	2P AMPMODU II SHRD HDR, RT ANG, TIN	TAB 2,3X0,64 W.ACTION PIN	26pos MQS .63 header THR 180deg Black
TE Part #1103391-1 Set HG-Q.4/2			
Documents			
Product Drawings 2P AMPMODU II SHRD HDR	, ST, TIN		

English

**CAD** Files

3D PDF

3D

Customer View Model

ENG\_CVM\_CVM\_280370-1\_U\_c-280370-1-u.2d\_dxf.zip

PCB Mount Header, Vertical, Board-to-Board, 2 Position, 2.54 mm [.1 in] Centerline, Partially Shrouded, Tin, Through Hole - Solder, AMPMODU Headers



English

Customer View Model ENG\_CVM\_CVM\_280370-1\_U\_c-280370-1-u.3d\_igs.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_280370-1\_U\_c-280370-1-u.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Environmental Compliance
Product Compliance Document
English
Product Compliance Document
English